

捷多邦,专业PCB打样工厂,24公时如今世代V32RH

Data Sheet

August 2000

File Number 4907

Radiation Hardened 3.3V Quad Differential Line Receiver

The Intersil HS-26CLV32RH is a radiation hardened 3.3V quad differential line receiver designed for digital data transmission over balanced lines, in low voltage, RS-422 protocol applications. Radiation hardened CMOS processing assures low power consumption, high speed, and reliable operation in the most severe radiation environments.

The HS-26CLV32RH has an input sensitivity of 200mV (Typ) over a common mode input voltage range of -4V to +7V. The receivers are also equipped with input fail safe circuitry, which causes the outputs to go to a logic "1" when the inputs are open. The device has unique inputs that remain high impedance when the receiver is disabled or powered-down, maintaining signal integrity in multi-receiver applications.

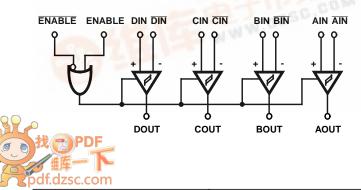
Specifications for Rad Hard QML devices are controlled by the Defense Supply Center in Columbus (DSCC). The SMD numbers listed here must be used when ordering.

Detailed Electrical Specifications for these devices are contained in SMD 5962-95689. A "hot-link" is provided on our homepage for downloading. www.intersil.com/spacedefense/space.asp

Ordering Information

ORDERING NO.	INTERNAL MKT. NO.	TEMP. RANGE (^o C)
5962F9568902QEC	HS1-26CLV32RH-8	-55 to 125
5962F9568902QXC	HS9-26CLV32RH-8	-55 to 125
596 <mark>2F9568902V9</mark> A	HS0-26CLV32RH-Q	25
596 <mark>2F9</mark> 568902VEC	HS1-26CLV32RH-Q	-55 to 125
5962F9568902VXC	HS9-26CLV32RH-Q	-55 to 125
HS1-26CLV32RH/PROTO	HS1-26CLV32RH/PROTO	-55 to 125
HS9-26CLV32RH/PROTO	HS9-26CLV32RH/PROTO	-55 to 125

Logic Diagram



Features

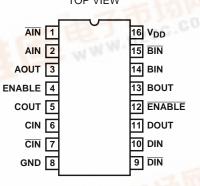
- Electrically Screened to SMD # 5962-95689
- QML Qualified per MIL-PRF-38535 Requirements
- 1.2 Micron Radiation Hardened CMOS

 - Single Event Upset LET100MeV/mg/cm²)
 - Single Event Latch-up Immune

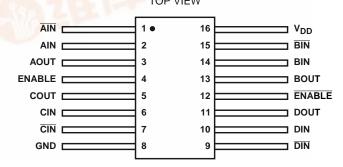
- Enable Input Levels $V_{IH} > (.7)(V_{DD}); V_{IL} < (.3)(V_{DD})$
- CMOS Output Levels V_{OH} > 2.55V; V_{OL} < 0.4V
- Input Fail Safe Circuitry
- High Impedance Inputs when Disabled or Powered-down
- Full -55^oC to 125^oC Military Temperature Range

Pinouts

HS1-26CLV32RH 16 LEAD CERAMIC SIDEBRAZE DIP MIL-STD-1835: CDIP2-T16 TOP VIEW



HS9-26CLV32RH 16 LEAD FLATPACK MIL-STD-1835: CDFP4-F16 TOP VIEW



Die Characteristics

DIE DIMENSIONS:

84 mils x 130 mils x 21 mils (2140µm x 3290µm)

INTERFACE MATERIALS:

Glassivation:

Type: PSG (Phosphorus Silicon Glass) Thickness: $8k\dot{A} \pm 1k\dot{A}$

Substrate:

AVLSI1RA, Silicon backside, V_{DD} backside potential

Metallization Mask Layout

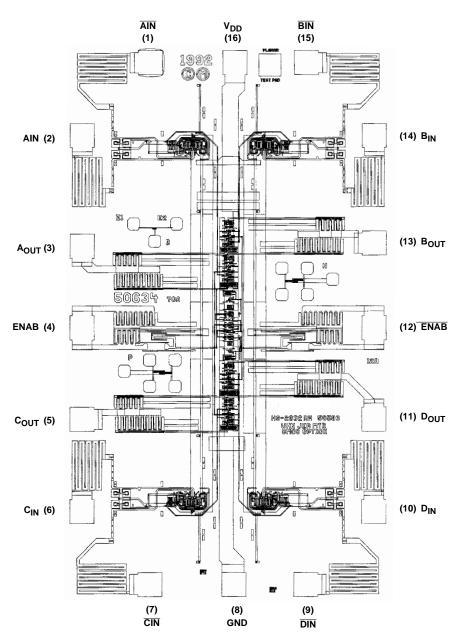
Metallization:

Bottom: Mo/Tiw Thickness: 5800Å ±1kÅ Top: Al/Si/Cu Thickness: 10kÅ ±1kÅ

Worst Case Current Density: <2.0 x 10⁵A/cm²

Bond Pad Size:

110µm x 100µm



HS-26CLV32RH

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